

LOW PHASE NOISE CLOCK MULTIPLIER

ICS601-21

Description

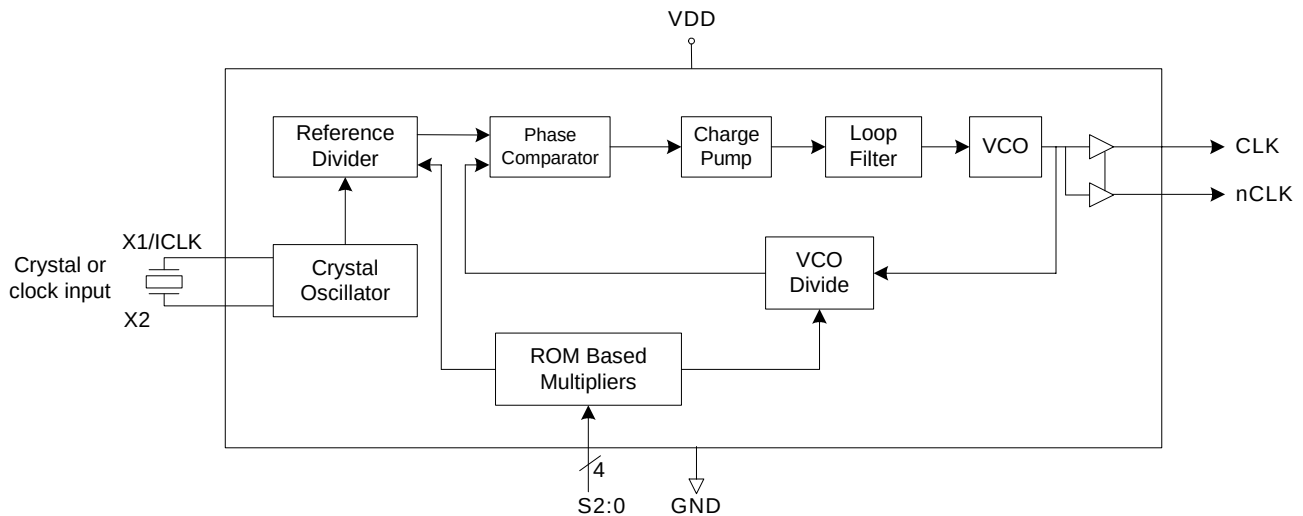
The ICS601-21 is a low-cost, low phase noise, high performance clock synthesizer for applications which require low phase noise and low jitter. It is ICS' lowest phase noise multiplier. Using ICS' patented analog and digital Phase Locked Loop (PLL) techniques, the chip accepts a 10 - 27 MHz crystal or clock input, and produces output clocks up to 220 MHz at 3.3 V.

This product is intended for clock generation. It has low output jitter (variation in the output period), but input to output skew and jitter are not defined nor guaranteed.

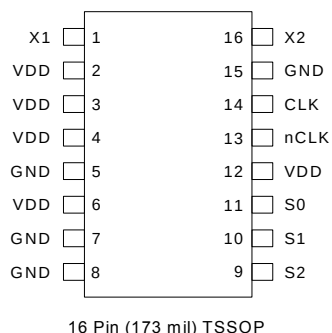
Features

- Fully integrated PLL, no external loop filter required
- Differential 3.3 V LVPECL outputs
- Uses fundamental 10 - 27 MHz crystal or clock
- Output clocks up to 220 MHz at 3.3 V
- Low phase noise: -122 dBc/Hz at 10 kHz
- Low jitter - 15 ps one sigma typ.
- Powerdown mode lowers power consumption
- Packaged in 16-pin TSSOP
- Advanced, low power, sub-micron CMOS process
- Operating voltage of 3.3 V
- Commercial temperature range available
- Available in Pb (lead) free package

Block Diagram



Pin Assignment



Multiplier Select Table

S2	S1	S0	Multiplier
0	0	0	x1
0	0	1	x2
0	1	0	x3
0	1	1	x4
1	0	0	x5
1	0	1	x6
1	1	0	x8
1	1	1	x16

0 = connect directly to ground

1 = connect directly to VDD

Pin Descriptions

Pin Number	Pin Name	Pin Type	Pin Description
1	X1	XI	Crystal or clock input. Connect to a 10-27 MHz fundamental parallel mode crystal or clock input.
2 - 4	VDD	Power	Connect to +3.3 V.
5	GND	Power	Connect to ground.
6	VDD	Power	Connect to +3.3 V.
7 - 8	GND	Power	Connect to ground.
9	S2	Input	Select pin 2. Internal pull-up resistor.
10	S1	Input	Select pin 1. Internal pull-up resistor.
11	S0	Input	Select pin 0. Internal pull-up resistor.
12	VDD	Power	Connect to +3.3 V.
13	nCLK	Output	Inverted differential clock output.
14	CLK	Output	Differential clock output.
15	GND	Power	Connect to ground.
16	X2	XO	Crystal connection. Connect to 10-27MHz fundamental parallel mode crystal or leave unconnected for clock input.

External Components

The ICS601-21 requires a minimum number of external components for proper operation. Decoupling capacitors of 0.01 μ F and 0.1 μ F should be connected between VDD and GND, as close to the part as possible. A 50 Ω terminating resistor should be used on each clock output. (See termination diagram on page 5). The crystal must be connected as close to the chip as possible. The crystal should be fundamental mode, parallel resonant. Do not use third overtone. For exact tuning when using a crystal, capacitors should be connected from pins X1 to ground and X2 to ground. In general, the value of these capacitors is given by the following equation, where CL is the crystal load capacitance: Crystal caps (pF) = (CL-5) x 2. So for a crystal with 16 pF load capacitance, two 22 pF caps can be used. For any given board layout, ICS can measure the board capacitance and recommend the exact capacitance value to use.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the ICS601-21. These ratings, which are standard values for ICS commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD	7 V
All Inputs and Outputs	-0.5 V to VDD+0.5 V
Ambient Operating Temperature, Commercial version	0 to +70 °C
Storage Temperature	-65 to +150 °C
Junction Temperature	125 °C
Soldering Temperature	260 °C

Recommended Operation Conditions

Parameter	Min.	Typ.	Max.	Units
Ambient Operating Temperature	0		+70	°C
Power Supply Voltage (measured in respect to GND)	+3.0		+3.6	V

DC Electrical Characteristics

VDD=3.3 V $\pm$ 10%, Ambient temperature 0 to +70°C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		3.0		3.6	V
Input High Voltage	V _{IH}	X1/ICLK pin only	VDD/2+1			V
Input Low Voltage	V _{IL}	X1/ICLK pin only			VDD/2-1	V

DC Electrical Characteristics (continued)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input High Voltage	V_{IH}	Input select pins	2		VDD	V
Input Low Voltage	V_{IL}	Input select pins			0.8	V
Output High Voltage	V_{OH}	Note 1	VDD-1.4		VDD-1.0	V
Output Low Voltage	V_{OL}	Note 1	VDD-2.0		VDD-1.7	V
Output Voltage Swing	V_{swing}	Peak to Peak	0.6		0.95	V
Operating Supply Current	IDD	Note 1, 125 MHz		30	45	mA
Input Capacitance	C_{IN}	Input select pins		5		pF
On Chip Pull-up Resistor	R_{PU}	Input select pins		510		k Ω

Note 1: Outputs terminated with 50 Ω to VDD-2V

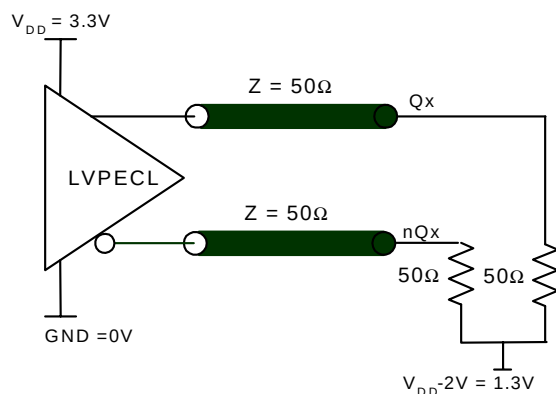
AC Electrical Characteristics

VDD = 3.3 V $\pm$ 10%, Ambient Temperature 0 to +70° C

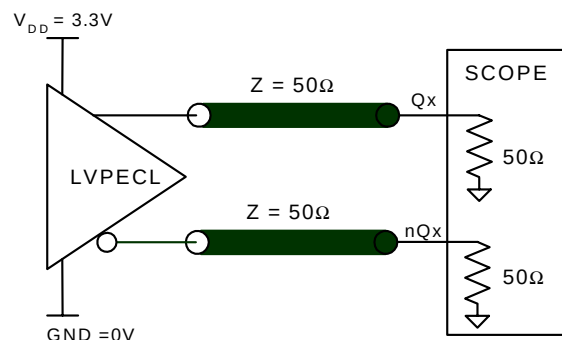
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Crystal Input Frequency	F_{in}	Note 2	10		27	MHz
Output Frequency			10		220	MHz
Output Rise Time	t_{OR}	20% to 80%, no load		600	900	ps
Output Fall Time	t_{OF}	80% to 20%, no load		900	1200	ps
Output Clock Duty Cycle		at VDD/2	45	50	55	%
Maximum Absolute Jitter, short term, 125 MHz		No load		$\pm$ 50	$\pm$ 75	ps
Maximum Jitter, one sigma, 125 MHz (x5)		No load		12	20	ps
Phase Noise, relative to carrier, 125 MHz (x5)		100 Hz offset	-90	-94		dBc/Hz
Phase Noise, relative to carrier, 125 MHz (x5)		1 kHz	-116	-120		dBc/Hz
Phase Noise, relative to carrier, 125 MHz (x5)		10 kHz offset	-118	-122		dBc/Hz
Phase Noise, relative to carrier, 125 MHz (x5)		100 kHz offset	-115	-119		dBc/Hz

Note 2: Input frequency limited by maximum output frequency and multiplication factor (I.e. For 16x, maximum input frequency is 13.75 MHz).

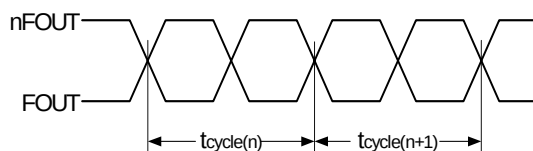
Parameter Measurement Information



3.3V LVPECL Driver Termination



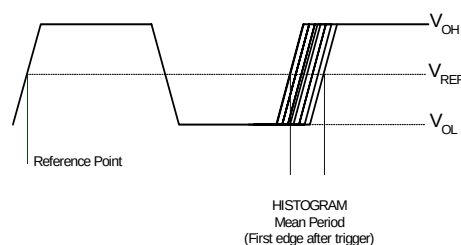
3.3V Output Load AC Test Circuit



$$t_{jit(cc)} = t_{cycle(n)} - t_{cycle(n+1)}$$

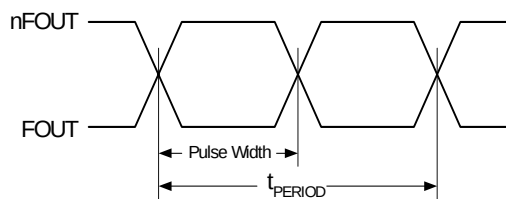
1000 Cycles

CYCLE-TO-CYCLE JITTER

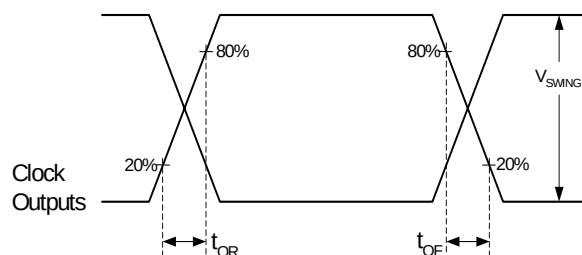


1s contains 68.26% of all measurements
 2s contains 95.4% of all measurements
 3s contains 99.73% of all measurements
 4s contains 99.99366% of all measurements
 6s contains $(100 - 1.973 \times 10^{-7})\%$ of all measurements

Period Jitter



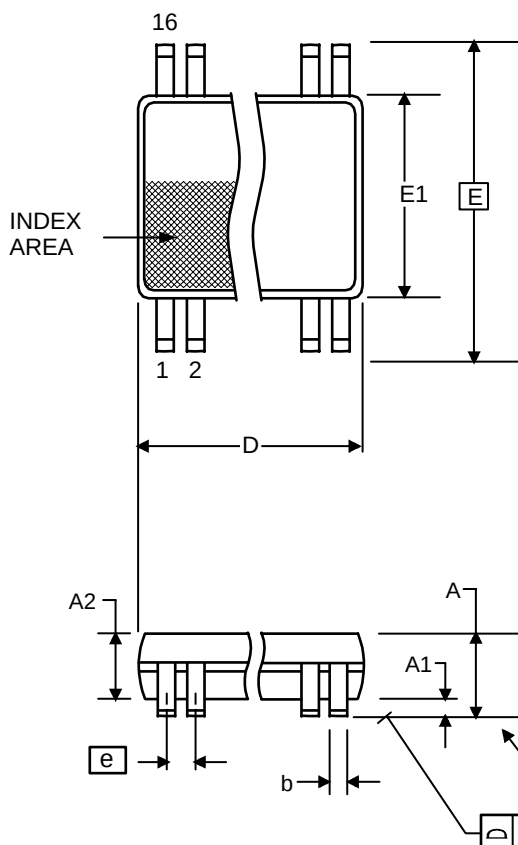
$$ODC = \frac{t_{PW}}{t_{PERIOD}}$$

OUTPUT DUTY CYCLE AND t_{PERIOD} 

OUTPUT RISE/FALL TIME

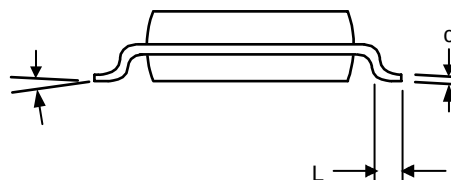
Package Outline and Package Dimensions (16-pin TSSOP, 173 Mil. Narrow Body)

Package dimensions are kept current with JEDEC Publication No. 95



Symbol	Millimeters		Inches*	
	Min	Max	Min	Max
A	--	1.20	--	0.047
A1	0.05	0.15	0.002	0.006
A2	0.80	1.05	0.032	0.041
b	0.19	0.30	0.007	0.012
C	0.09	0.20	0.0035	0.008
D	4.90	5.1	0.193	0.201
E	6.40 BASIC		0.252 BASIC	
E1	4.30	4.50	0.169	0.177
e	0.65 Basic		0.0256 Basic	
L	0.45	0.75	0.018	0.030
α	0°	8°	0°	8°
aaa	--	0.10	--	0.004

*For reference only. Controlling dimensions in mm.



Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
601G-21	ICS601G-21	Tubes	16-pin TSSOP	0 to +70° C
601G-21T	ICS601G-21	Tape and Reel	16-pin TSSOP	0 to +70° C
601G-21LF	601G-21LF	Tubes	16-pin TSSOP	0 to +70° C
601G-21LFT	601G-21LF	Tape and Reel	16-pin TSSOP	0 to +70° C

Parts that are ordered with a "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

While the information presented herein has been checked for both accuracy and reliability, Integrated Circuit Systems (ICS) assumes no responsibility for either its use or for the infringement of any patents or other rights of third parties, which would result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial applications. Any other applications such as those requiring extended temperature range, high reliability, or other extraordinary environmental requirements are not recommended without additional processing by ICS. ICS reserves the right to change any circuitry or specifications without notice. ICS does not authorize or warrant any ICS product for use in life support devices or critical medical instruments.

Innovate with IDT and accelerate your future networks. Contact:

www.IDT.com

For Sales

800-345-7015
408-284-8200
Fax: 408-284-2775

For Tech Support

<product line email>
<product line phone>

Corporate Headquarters

Integrated Device Technology, Inc.
6024 Silver Creek Valley Road
San Jose, CA 95138
United States
800 345 7015
+408 284 8200 (outside U.S.)

Asia Pacific and Japan

Integrated Device Technology
Singapore (1997) Pte. Ltd.
Reg. No. 199707558G
435 Orchard Road
#20-03 Wisma Atria
Singapore 238877
+65 6 887 5505

Europe

IDT Europe, Limited
Prime House
Barnett Wood Lane
Leatherhead, Surrey
United Kingdom KT22 7DE
+44 1372 363 339



www.IDT.com